



Inductive Component

Preliminary data sheet

RM5 PTH Transformer

B78384P9607A005

Date: 2013-2-4

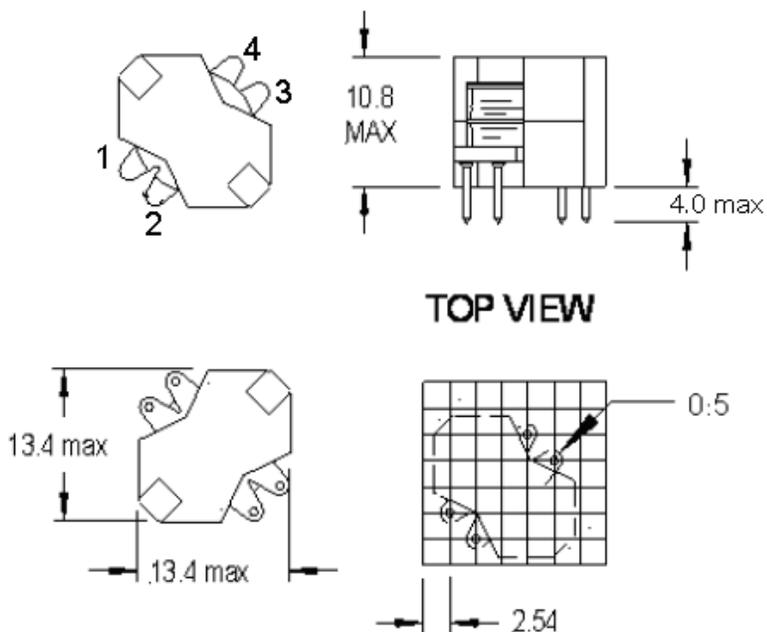
Version: 55-01

Preliminary data sheet

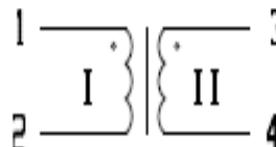
Customer:

Specification:

■ Dimensions in mm:



Schematic:



Marking:

EPCOS
Middle block
Date code

Electrical Characteristics: (specified @25°C if not mentioned otherwise) *) typical value

All values without tolerances are typical values

Inductance: L (1-2)=L(3-4)	2.0 H Min.	1KHZ,1V
TR :W1:W2	+1:1	
Hi-Pot: W1 to W2	500 Vrms	50Hz / 1s
DCR(1-2)	60 ohm max	25°C
DCR(3-4)	80 ohm max	25°C

Packaging:

Polyfoam Tray

Packing unit: 500 pcs/box

Remark:

1. RoHS Compatible.

Operation temperature: -40°C ~ +85°C

Preliminary data sheet

Cautions and warnings

- Additional information is contained in our data books, which are also available on the internet. Particular attention should be paid to the derating curves given there. The soldering conditions given there should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not to the housing.
- If the components are to be washed varnished, it is necessary to check whether any washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.
Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g. ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.
- The following points must be observed if the components are potted in customer applications:
 - Many potted materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties and, in extreme cases, can damage the core or plastic housing mechanically;
 - It is necessary to check whether the potting material used attacks or destroys the wire insulation, plastics or glue;
 - The effect of the potting material can change the high frequency behaviour of the components.
- Ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer specific products, conclusive validation of the components in the circuit can only be carried out by the customer.

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